Vishay Siliconix



**TO-220AB** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}\left(\Omega\right)$ 

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>q</sub> max. (nC)

Configuration

## **Power MOSFET**

S

N-Channel MOSFET

2.2

600

23

5.4

11

Single

 $V_{GS} = 10 V$ 

### **FEATURES**

· Low gate charge Qg results in simple drive requirement



- Improved gate, avalanche, and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Effective Coss specified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptable power supply
- High speed power switching

### TYPICAL SMPS TOPOLOGY

Single Transistor flyback

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFBC30APbF
Lead (Pb)-free and halogen-free	IRFBC30APbF-BE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	• V	
Gate-source voltage			V <sub>GS</sub>	± 30		
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	3.6		
		T <sub>C</sub> = 100 °C		2.3	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	14		
Linear derating factor				0.69	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	290	mJ	
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	3.6	A	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	7.4	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		PD	74	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	7.0	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	•••	
Soldering recommendations (peak temperature) <sup>d</sup>	For	10 s		300	°C	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11) b. Starting T<sub>J</sub> = 25 °C, L = 41 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3.6 A (see fig. 12) c. I<sub>SD</sub>  $\leq$  3.6 A, dI/dt  $\leq$  170 A/µs, V<sub>DD</sub>  $\leq$  V<sub>DS</sub>, T<sub>J</sub>  $\leq$  150 °C

d. 1.6 mm from case

S21-0868-Rev. C, 16-Aug-2021

www.vishay.com

Vishay Siliconix

THERMAL RESISTANCE RAT	TINGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62 0.50 - - 1.7						
Case-to-sink, flat, greased surface	R <sub>thCS</sub>				°C/W			
Maximum junction-to-case (drain)	R <sub>thJC</sub>					1		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, PARAMETER	, unless otherwi	1	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$			600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA			-	0.67	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$			2.0	-	4.5	V
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}$			-	-	± 100	nA
Zero gate voltage drain current	1	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	25	μA	
	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V, V	/ <sub>GS</sub> = 0 V,	V, T <sub>J</sub> = 125 °C				250
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 2.2 A <sup>b</sup>	-	-	2.2	Ω
Forward transconductance	9 <sub>fs</sub>	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 2.2 \text{ A}^{\text{b}}$		2.1	-	-	S	
Dynamic						•	•	
Input capacitance	C <sub>iss</sub>	V	′ <sub>GS</sub> = 0 V,		-	510	-	
		• • • • • • • • • • • • • • • • • • • •					1	

Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	510	-	
Output capacitance	C <sub>oss</sub>			-	70	-	ъĘ
Reverse transfer capacitance	C <sub>rss</sub>			-	3.5	-	
Output capacitance	C <sub>oss</sub>		V <sub>DS</sub> = 1.0 V, f = 1.0 MHz	-	730	-	pF
		$V_{GS} = 0 V$	$V_{GS} = 0 V$ $V_{DS} = 480 V, f = 1.0 MHz$		19	-	
Effective output capacitance	C <sub>oss</sub> eff.		$V_{DS}$ = 0 V to 480 V <sup>c</sup>	-	31	-	
Total gate charge	Qg		I <sub>D</sub> = 3.6 A, V <sub>DS</sub> = 480 V see fig. 6 and 13 <sup>b</sup>	-	-	23	nC
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	-	5.4	
Gate-drain charge	Q <sub>gd</sub>	-		-	-	11	
Turn-on delay time	t <sub>d(on)</sub>			-	9.8	-	
Rise time	t <sub>r</sub>	$V_{DD}$ = 300 V, $I_D$ = 3.6 A, $R_g$ = 12 $\Omega,R_D$ = 82 $\Omega,$ see fig. 10 $^{\rm b}$		-	13	-	ns
Turn-off delay time	t <sub>d(off)</sub>			-	19	-	
Fall time	t <sub>f</sub>			-	12	-	
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.8	-	4.6	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.6	А
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	14	A
Body diode voltage	V <sub>SD</sub>	$T_{\rm J}$ = 25 °C, $I_{\rm S}$ = 3.6 A, $V_{\rm GS}$ = 0 V <sup>b</sup>		-	-	1.6	V
Body diode reverse recovery time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 3.6 \text{ A}, dI/dt = 100 \text{ A}/\mu \text{s}^{\text{b}}$		-	400	600	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	1.1	1.7	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )					

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

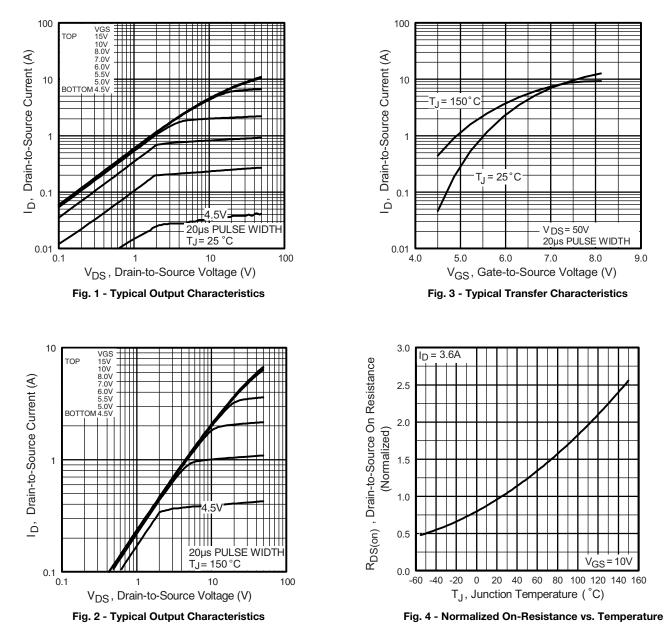
c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 

2



Vishay Siliconix

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



3



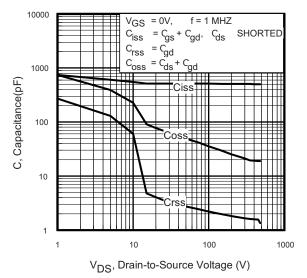


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

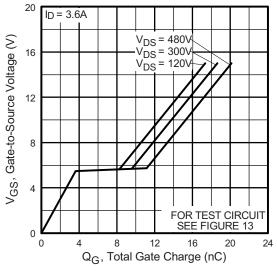


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

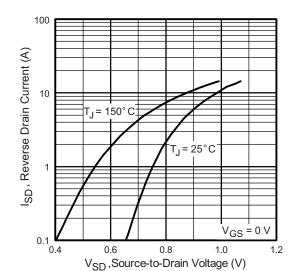


Fig. 7 - Typical Source-Drain Diode Forward Voltage

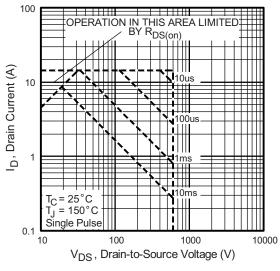


Fig. 8 - Maximum Safe Operating Area



### Vishay Siliconix

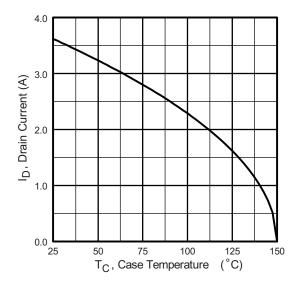


Fig. 9 - Maximum Drain Current vs. Case Temperature

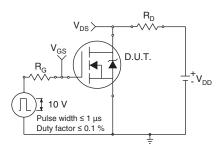


Fig. 10a - Switching Time Test Circuit

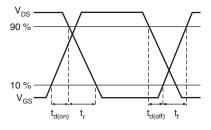
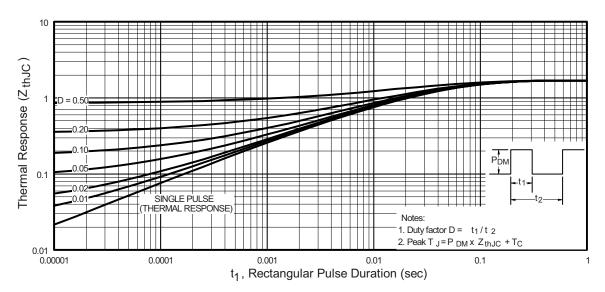


Fig. 10b - Switching Time Waveforms





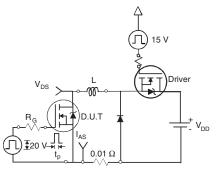
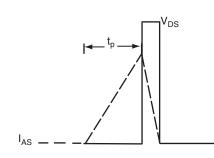
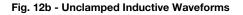


Fig. 12a - Unclamped Inductive Test Circuit





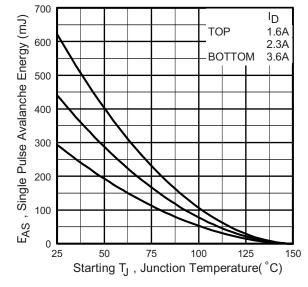
S21-0868-Rev. C, 16-Aug-2021

5

Document Number: 91108

Vishay Siliconix







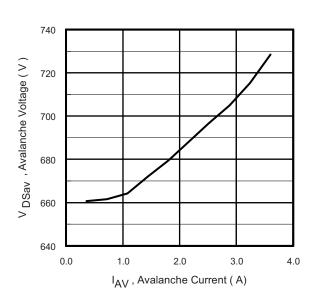
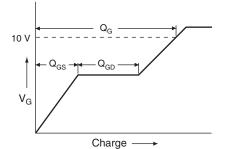
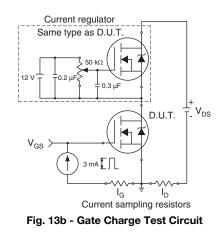
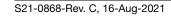


Fig. 12d - Typical Drain-to-Source Voltage vs. Avalanche Current





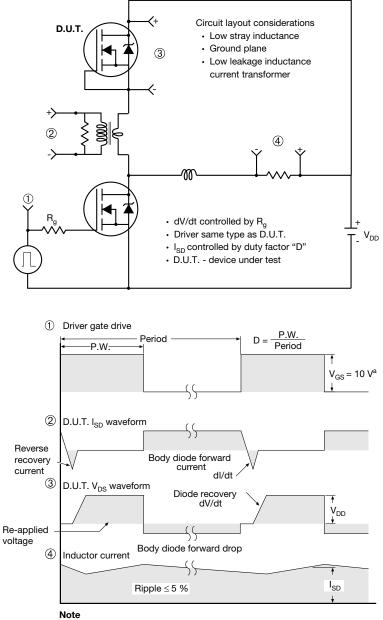




6



### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS}$  = 5 V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?91108">www.vishay.com/ppg?91108</a>.

7



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2024 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

Revision: 01-Jul-2024